

AAP Gen 7 (TO-240AA) Power Modules Schottky Rectifier, 200 A



PRIMARY CHARACTERISTICS				
I _{F(AV)}	200 A			
V_{R}	100 V			
Package	AAP Gen 7 (TO-240AA)			
Circuit configuration	Two diodes common anode			

MECHANICAL DESCRIPTION

The AAP Gen 7, new generation of ADD-A-PAK module, combines the excellent thermal performances obtained by the usage of exposed direct bonded copper substrate, with advanced compact simple package solution and simplified internal structure with minimized number of interfaces.

FEATURES

- 175 °C T_J operation
- · Low forward voltage drop
- High frequency operation
- · Low thermal resistance
- UL approved file E78996





· Designed and qualified for industrial level

BENEFITS

- · Excellent thermal performances obtained by the usage of exposed direct bonded copper substrate
- High surge capability
- · Easy mounting on heatsink

ELECTRICAL DESCRIPTION / APPLICATIONS

The VS-VSKJS203.. Schottky rectifier common anode has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature.

Typical applications are in high current switching power supplies, plating power supplies, UPS systems, converters, freewheeling diodes, welding, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	200	A			
V _{RRM}		100	V			
I _{FSM}	t _p = 5 μs sine	12 800	A			
V _F	100 A _{pk} , T _J = 125 °C	0.87	V			
T _J	Range	-55 to +175	°C			

VOLTAGE RATINGS			
PARAMETER	SYMBOL	VS-VSKJS203/100	UNITS
Maximum DC reverse voltage	V_{R}	100	V
Maximum working peak reverse voltage	V_{RWM}	100	V

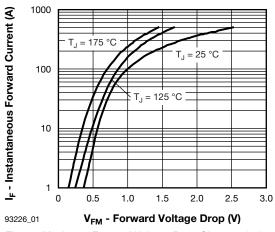


ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average	per module		50 % duty cycle at T _C = 121 °C, rectangular waveform		200	
forward current	per leg	I _{F(AV)}			100	
Maximum peak one cycle		5 μs sine or 3 μs rect. pulse	Following any rated load condition and with	12 800	Α	
non-repetitive surge current		IFSM	10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	1700	
Non-repetitive avalanche energ	у	E _{AS}	T _J = 25 °C, I _{AS} = 5.5 A, L = 1 mH		15	mJ
Repetitive avalanche current		I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		1	Α

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward with me due of		100 A	T _J = 25 °C	0.99	V
		200 A		1.34	
Maximum forward voltage drop	V_{FM}	100 A	T _J = 125 °C	0.87	
		200 A		1.09	
Maximum reverse leakage current	I _{RM}	T _J = 25 °C	V _R = Rated V _R	3	mA
waximum reverse leakage current		T _J = 125 °C		65	IIIA
Maximum junction capacitance	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		2750	pF
Typical series inductance	L _S	Measured lead to lead 5 mm from package body		7.0	nΗ
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs
Maximum RMS insulation voltage	V _{INS}	50 Hz		3000 (1 min) 3600 (1 s)	V

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	e	T _J , T _{Stg}		-55 to +175	°C
Maximum thermal resistance, junction to case per leg		R _{thJC}	DC operation	0.52	°C/W
Typical thermal resistance, case to heatsink per module		R _{thCS}		0.1	C/VV
Approximate weight				75	g
Approximate weight				2.7	oz.
Mounting torque ± 10 % to heatsink busbar		A mounting compound is recommended and the torque should be rechecked after a period of 3 h to allow for the	4	Nm	
		spread of the compound.	3	INIII	
Case style	•		JEDEC®	TO-240AA co	mpatible

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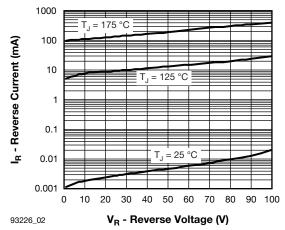


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

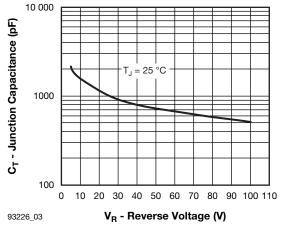


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

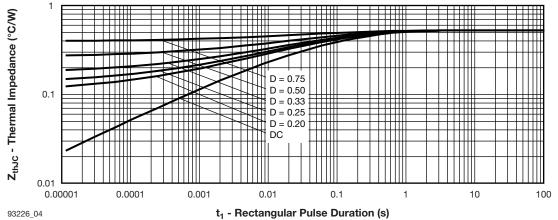


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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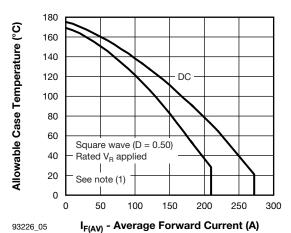


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

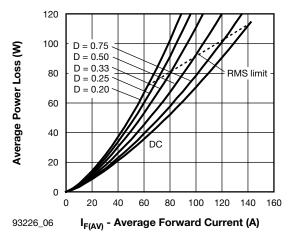


Fig. 6 - Forward Power Loss Characteristics

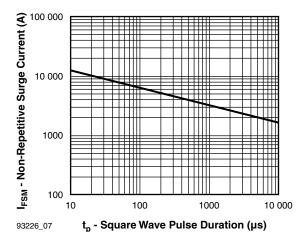


Fig. 7 - Maximum Non-Repetitive Surge Current

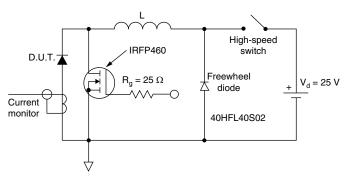


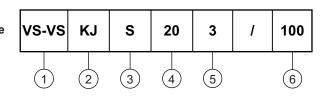
Fig. 8 - Unclamped Inductive Test Circuit

Note

Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; $Pd = forward power loss = I_{F(AV)} \times V_{FM} at (I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = inverse power loss = V_{R1} \times I_R (1 - D)$; I_R at $V_{R1} = 80 \%$ rated V_R

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Circuit configuration:

KJ = ADD-A-PAK - 2 diodes common anode

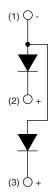
3 - S = Schottky diode

- Average current rating (20 = 200 A)

5 - Product silicon identification

6 - Voltage rating (100 = 100 V)

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95369			



ADD-A-PAK Generation VII - Diode

DIMENSIONS in millimeters (inches)





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